**N-Channel Enhancement Mode MOSFET** 

### **Product Summary**

Vds	40V
ID(@Tc=25℃)	85A
R <sub>DS(ON)</sub> (@VGs=10V I <sub>D</sub> =20A)	≤3.0mΩ
R <sub>DS(ON)</sub> (@VGs=4.5V I <sub>D</sub> =20A)	≤4.0mΩ



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DFN5\*6-8L

# Features

- SGT MOSFET Technology
- ◆ 100% Avalanche Tested
- ◆ Low Gate Charge
- Excellent ON Resistance
- Extremely Low Threshold Voltage
- RoHS complian

### Applications

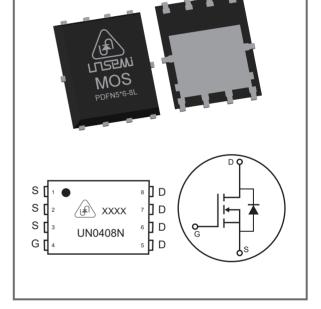
- ♦ DC/DC Converter
- Battery Management System
- High power inverter system
- ◆ Industrial and Motor Drive applications

### Package Marking And Ordering information

Part Number	Package Type	Packaging	Reel(pcs)
UN0408N2R0-PD56	DFN5*6-8L	Tape & Reel	5000

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### Absolute Maximum Ratings Tc = 25℃ unless otherwise specified

Parameter		Symbol	Maximum	Units	
Drain to Source Voltage		Vds	40	V	
Continuous Drain Current <sup>1)</sup>	@Tc=25°C	- lo -	85	A	
	@Tc=100°C		70		
Drain Current Pulsed 2)		ldм	110	А	
Drain current of silicon wafer <sup>3)</sup>		ldsw	240	А	
Gate-Source Voltage		Vgs	±20	V	
Single Pulsed Avalanche Energy 4)		Eas	190	mJ	
Power Dissipation	@Tc=25°C	Pp	83	. W	
	@Tc=100°C	ΓD	33		
Junction and Storage Temperature Range		Tstg,TJ	-55~150	Ĵ	

### **Thermal Characteristics**

Parameter	Symbol	Max	Units
Thermal Resistance from Junction to Ambient	Reja	61	°C/W
Thermal Resistance, Junction to Case	Rejc	1.5	°C/W

Notes:

1) The maximum current rating is package limited.

2) Single pulse width limited by junction temperature .

3) The maximum current rating is silicon wafer limited.

4) Limited by  $T_{J(MAX)}$ , starting  $TJ=25^{\circ}C$ , Rg=25 $\Omega$ , L=0.5mH.

5) Design parameters, guaranteed by design, not subject to production.



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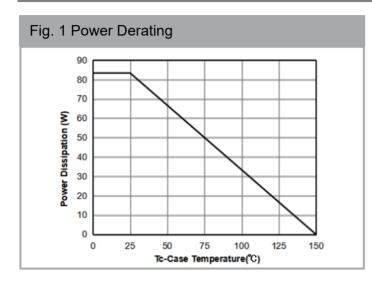
### Electrical Characteristics at Tc = $25^{\circ}$ C unless otherwise specified

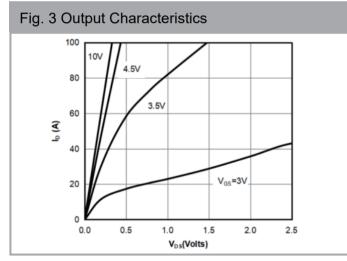
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
STATIC PARAMETERS						
Drain-Source Breakdown Voltage	BVDSS	Vgs = 0V, ID = 250uA	40			V
Drain-Source Leakage Current	IDSS	Vds = 40V , Vgs = 0V			1.0	μA
Gate-source leakage current	lgss	Vgs = ±20V , Vds = 0V			±100	nA
Gate-Source Threshold Voltage	Vgs(th)	Vgs = Vds , Id = 250µA	1.0	2.0	2.5	V
Drain-Source On-State Resistance		Vgs = 10V , Id = 20A		2.0	3.0	mΩ
	Rds(on)	Vgs = 4.5V , Id = 20A		3.2	4.0	mΩ
Forward Transconductance	gfs	VDS = 5.0V, ID = 20A		64		S
E	Body-Diode	PARAMETERS				
Drain-Source Diode Forward Voltage	Vsd	Is = 1A, Vgs = 0V		0.7	1.0	V
Body Diode Reverse Recovery Time	trr	IF = 20A		33.4		ns
Body Diode Reverse Recovery Charge	Qrr	di/dt = 100A/µs		20.46		nC
	DYNAMIC	PARAMETERS <sup>5)</sup>				
Gate Resistance	Rg	F = 1MHZ		1.0		Ω
Input Capacitance	Ciss	Vgs = 0V		3039		pF
Output Capacitance	Coss	Vds = 20V		535		pF
Reverse Transfer Capacitance	Crss	F = 1MHz		474		pF
Gate charge Total	Qg			76.2		nC
Gate to Source Charge	Qgs	Vgs = 10V Vps = 20V		10.4		nC
Gate to Drain Charge	Qgd	ID = 20A		26.3		nC
Turn-On Delay Time	td(ON)	VDS = 20V, VGS = 10V RL = 2.5Ω, RG = 3Ω		13		ns
Turn-On Rise Time	tr			39.4		ns
Turn-Off Delay Time	td(OFF)			37		ns
Turn-Off Fall Time	tf			28.2		ns

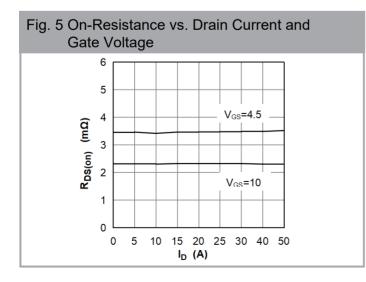


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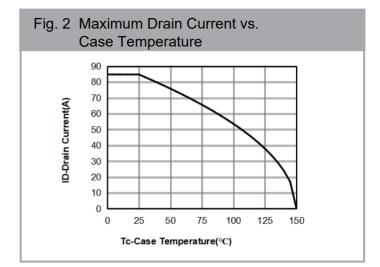
#### **Electrical Characteristics Curves**

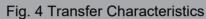


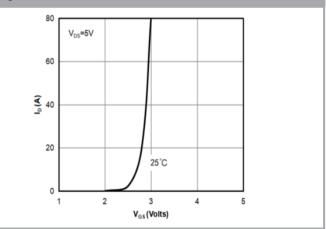




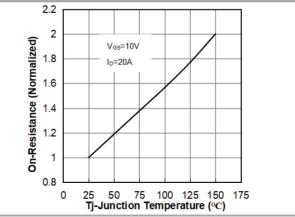
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#### Fig. 6 On-Resistance vs. Junction Temperature/ Normalized On-Resistance



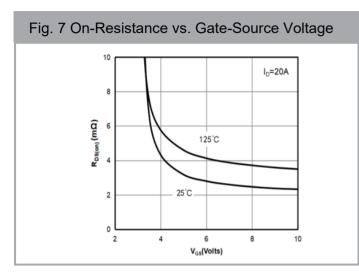
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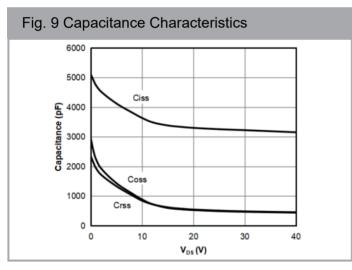
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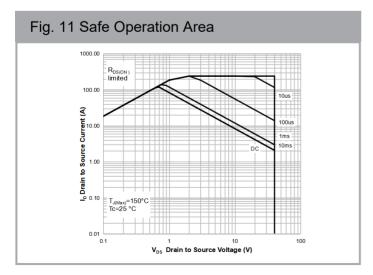


### N-Channel Enhancement Mode MOSFET ROHS

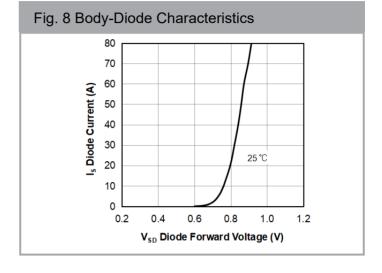
#### **Electrical Characteristics Curves**



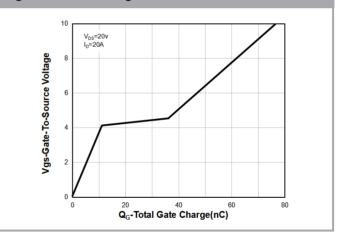




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#### Fig. 10 Gate Charge Characteristics

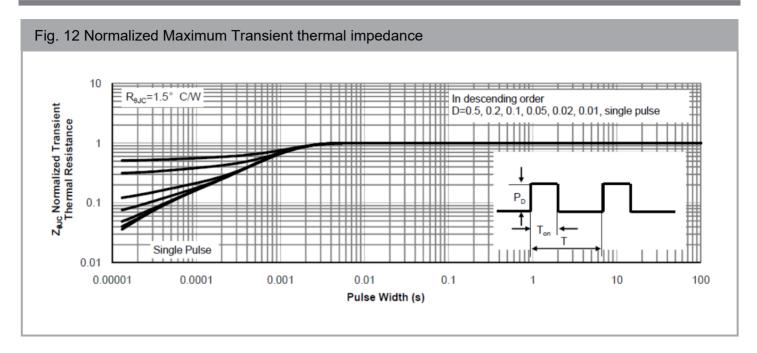




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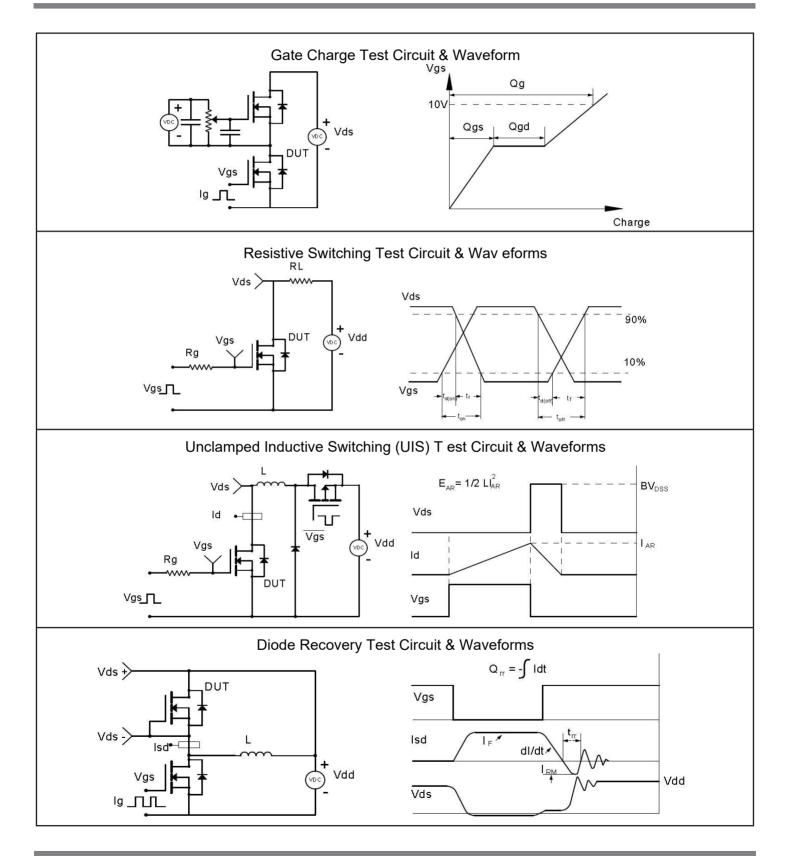
#### **Electrical Characteristics Curves**





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#### **Test Circuit**



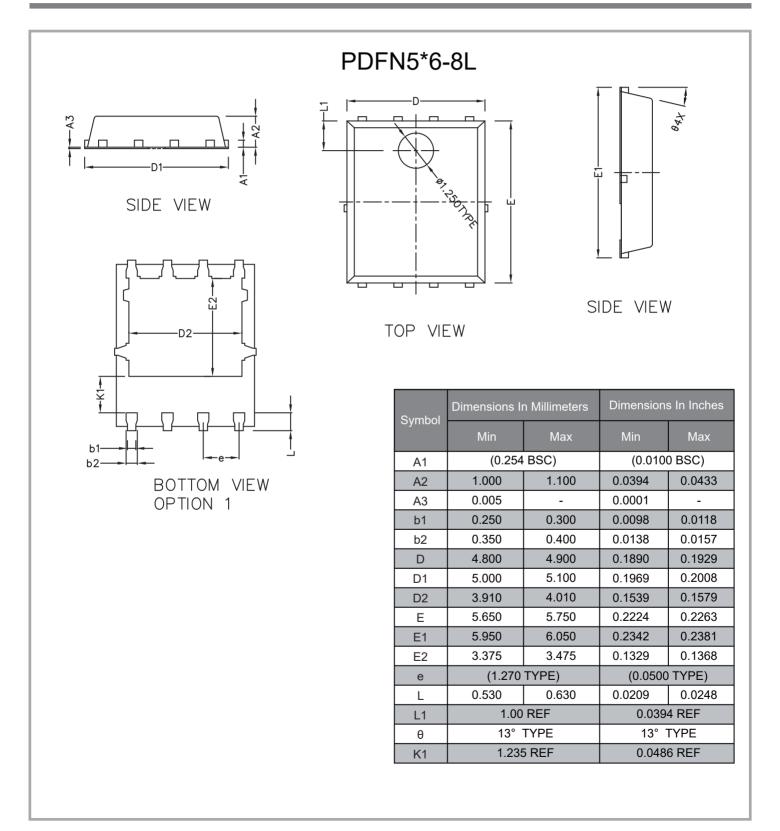
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### DFN5\*6-8L Package Outine & Dimensions (Units: mm / in)



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